MITSUBISHI STORAGE CARD

FLASH DRIVES

2.5" Flash Drive

Connector Type

IDE ATA 44-pin

MF6128M-02BJxx MF6256M-02BJxx MF6512M-02BJxx MF6640M-02BJxx MF601G2-02BJxx

DESCRIPTION

Mitsubishi's Flash Drives provide large memory capacities on a device approximately the size of a 2.5" IDE Type Hard Disk (101.85mm(L) \times 69.85mm (W) \times 8.47mm (T)).

Available in 128MB, 256MB, 512MB, 640MB and 1.2GB capacities.

FEATURES

- 2.5", IDE ATA 44-pin
- Single 5V Supply
- Up to 1.2GB maximum
- Nonvolatile, No Batteries Required
- High reliability based on internal ECC function
- Fast read/write performance

Read: 5MB/s(max.)

Write: 128MB card = 2.0MB/s(max.)

The others = 3.0MB/s(max.)

- Multiword DMA commands supported.
- 100,000 program/erase cycles

APPLICATIONS

- Computers
- Data Communication
- Office Automation
- Industrial
- Consumer

PRODUCT LIST

| | Memory capacity (Bytes) | Data Bus width(bits) | Memory | Cylinder | Head | Sector | Out line |
|----------------|----------------------------|-------------------------|--------------------|----------|------|--------|----------|
| MF6128M-02AJxx | 128,057,344 | | 256Mbit Flash x 4 | 977 | 8 | 32 | |
| MF6256M-02AJxx | 257,163,264 | | 256Mbit Flash x 8 | 981 | 16 | 32 | 2.5" |
| MF6512M-02AJxx | 515,579,904 | 8/16 | 256Mbit Flash x 16 | 999 | 16 | 63 | IDE |
| MF6640M-02AJxx | 640,475,136 | | 256Mbit Flash x 20 | 1241 | 16 | 63 | |
| MF601G2-02AJxx | 1,219,534,848 | | 256Mbit Flash x 40 | 2363 | 16 | 63 | |



PIN ASSIGNMENT

| Pin | Signal | I/O | Pin | Signal | I/O |
|-----|-----------------|-----|-----|-----------------|-----|
| 1 | RESET# | I | 2 | GND | - |
| 3 | DD7 | I/O | 4 | DD8 | I/O |
| 5 | DD6 | I/O | 6 | DD9 | I/O |
| 7 | DD5 | I/O | 8 | DD10 | I/O |
| 9 | DD4 | I/O | 10 | DD11 | I/O |
| 11 | DD3 | I/O | 12 | DD12 | I/O |
| 13 | DD2 | I/O | 14 | DD13 | I/O |
| 15 | DD1 | I/O | 16 | DD14 | I/O |
| 17 | DD0 | I/O | 18 | DD15 | I/O |
| 19 | GND | - | 20 | (keypin) | - |
| 21 | DMARQ | 0 | 22 | GND | - |
| 23 | DIOW# | I | 24 | GND | - |
| 25 | RIOR# | | 26 | GND | - |
| 27 | IORDY | 0 | 28 | CSEL | - I |
| 29 | DMACK# | I | 30 | GND | - |
| 31 | INTRQ | 0 | 32 | IOCS16# | 0 |
| 33 | DA1 | | 34 | PDIAG# | I/O |
| 35 | DA0 | I | 36 | DA2 | |
| 37 | CS0# | I | 38 | CS1# | I |
| 39 | DASP# | I/O | 40 | GND | - |
| 41 | V _{DD} | - | 42 | V _{DD} | - |
| 43 | GND | - | 44 | GND | - |



Master/Slave/Cable Select Configuration

(1) Master(or single) [Default] If all of pins A, B, C, D are Open, the drive is a Master.

| 43 | | | | | | | | | | | | | | | | | | | | | 1 | С | А |
|----|---|---|---|---|---|---|---|---|---|---|---|----|---|---|---|---|---|---|---|---|---|---|---|
| • | | | | | | | | | | | | | | | | | | | | | | | |
| ٠ | ٠ | ٠ | ٠ | ٠ | ٠ | ٠ | ٠ | ٠ | ٠ | ٠ | ٠ | | ٠ | ٠ | ٠ | ٠ | ٠ | ٠ | ٠ | ٠ | ٠ | ٠ | ٠ |
| 44 | | | | | | | | | | | | 20 | | | | | | | | | 2 | D | В |

(2) Slave

If pins C, D are open and jumper position A-B is used, the drive is a Slave.

| 43 | | | | | | | | | | | | | | | | | | | | | 1 | С | А |
|----|---|---|---|---|---|---|---|---|---|---|---|----|---|---|---|---|---|---|---|---|---|---|---|
| • | • | • | • | • | • | • | • | • | • | • | • | ٠ | • | • | • | • | • | • | • | • | • | • | |
| • | • | • | • | • | • | • | • | • | • | • | • | | • | • | • | • | • | • | • | • | • | • | |
| 44 | | | | | | | | | | | | 20 | | | | | | | | | 2 | D | В |

(3) Cable Select [Default]

If jumper position D-B is used and pins C, A is open, Master/Slave setting is determined by the condition of CSEL signal from the host.

| 43 | | | | | | | | | | | | | | | | | | | | | 1 | СA |
|----|---|---|---|---|---|---|---|---|---|---|---|----|---|---|---|---|---|---|---|---|---|-----|
| • | ٠ | ٠ | ٠ | ٠ | ٠ | ٠ | ٠ | ٠ | ٠ | ٠ | ٠ | ٠ | ٠ | ٠ | ٠ | ٠ | ٠ | ٠ | ٠ | ٠ | ٠ | • • |
| • | ٠ | ٠ | ٠ | ٠ | ٠ | ٠ | ٠ | ٠ | ٠ | ٠ | ٠ | | ٠ | ٠ | ٠ | ٠ | ٠ | ٠ | ٠ | ٠ | ٠ | |
| 44 | | | | | | | | | | | | 20 | | | | | | | | | 2 | DВ |

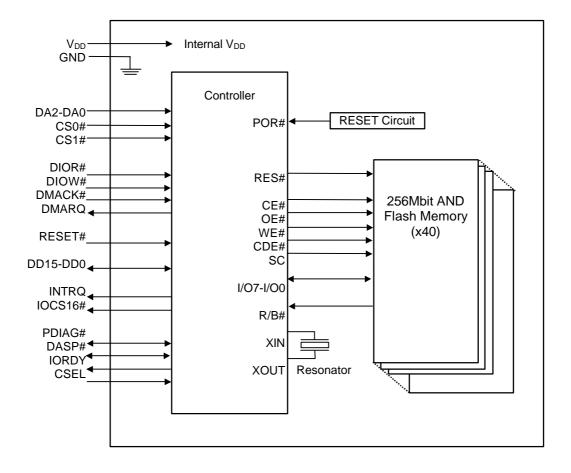


Signal Description

| Signal Description Signal Name | I/O | Pin No. | Description |
|------------------------------------|-----|--|--|
| Address bus[DA2-DA0] | I | 36, 33, 35 | Signals DA2-DA0 are address bus. DA2 is the MSB and DA0 is the LSB. |
| Data bus[D15-D0] | I/O | 18, 16, 14, 12, 10, 8, 6, 4, 3, 5, 7, 9, 11, 13, 15, 17 | Signals DD15-DD0 are data bus. |
| Chip select[CS0#, CS1#] | I | 37, 38 | CS0# is used to select the Command Block Registers. CS1# is used to select the Control Block Registers. |
| Drive I/O read[DIOR#] | I | 25 | DIOR# is used to read data from the Drive's I/O space. |
| Drive I/O write[DIOW#] | | 23 | DIOW# is used to write data to the Drive's I/O space. |
| DMA acknowledge[DMACK#] | I | 29 | This signal shall be used by the host in response to DMARQ to either acknowledge that data has been accepted, or that data is available. |
| DMA request[DMARQ] | 0 | 21 | This signal, used for DMA data transfer between host and drive, shall be asserted by the drive when it is ready to transfer data to or from the host. |
| Drive interrupt[INTRQ] | 0 | 31 | This signal is active high interrupt request to the host. |
| Drive 16-bit I/O[IOCS16#] | 0 | 32 | This output signal is asserted when the I/O port address is capable of 16-bit access. |
| Drive active/drive1 present[DASP#] | I/O | 39 | This signal is the DISK Active/Slave Present signal in the Master/Slave handshake protocol. |
| Drive reset[RESET#] | I | 1 | This input pin is the active low hardware reset from the host. |
| I/O channel ready[IORDY] | 0 | 27 | This signal is asserted to delay completion of the memory or I/O access cycle. |
| Passed diagnostics[PDIAG#] | I/O | 34 | This signal is the Pass Diagnostic signal in the Master/Slave handshake protocol. |
| Cable select[CSEL] | Ι | 28 | This signal is used to configure this Drive as a Master or a Slave. When this signal is grounded, this Drive is configured as a Master. When this signal is Open, this Drive is configure as a Slave. |
| V _{DD} | - | 41, 42 | 5V power. |
| GND | - | 2, 19, 22, 24, 26, 30, 40, 43, 44 | Ground. |



BLOCK DIAGRAM





MITSUBISHI STORAGE CARD

MF6XXXX-02BJXX series FLASH DRIVES

IDE ATA Interface

| CS1# | CS0# | DA2-DA0 | R | egister |
|------|------|---------|---------------------------------|----------------------------------|
| | | | DIOR#="L" | DIOW#="L" |
| 1 | 0 | 0h | Data Register(DD15-DD0) | Data Register(DD15-DD0) |
| 1 | 0 | 1h | Error Register(DD7-DD0) | Feature Register(DD7-DD0) |
| 1 | 0 | 2h | Sector Count Register(DD7-DD0) | Sector Count Register(DD7-DD0) |
| 1 | 0 | 3h | Sector Number Register(DD7-DD0) | Sector Number Register(DD7-DD0) |
| 1 | 0 | 4h | Cylinder Low Register(DD7-DD0) | Cylinder Low Register(DD7-DD0) |
| 1 | 0 | 5h | Cylinder High Register(DD7-DD0) | Cylinder High Register(DD7-DD0) |
| 1 | 0 | 6h | Drive Head Register(DD7-DD0) | Drive Head Register(DD7-DD0) |
| 1 | 0 | 7h | Status Register(DD7-DD0) | Command Register(DD7-DD0) |
| 0 | 1 | 6h | Alt. Status Register(DD7-DD0) | Device Control Register(DD7-DD0) |
| 0 | 1 | 7h | Drive Address Register(DD7-DD0) | invalid |



ATA Register Specifications

Data Register

This register is a 16 bit register which is used to transfer data blocks between the card data buffer and the host. Data may be transferred by either a series of word accesses to the Data register or a series of byte accesses to the Data register.

| DD1 | DD1 | DD1 | DD1 | DD1 | DD9 | DD8 |
|-----|-----|---------|---------|-----|-----|-----|
| 4 | 3 | 2 | 1 | 0 | | |
| | | Data \ | Nord | | | |
| | | Odd Dat | ta Byte | | | |

| DD7 | DD6 | DD5 | DD4 | DD3 | DD2 | DD1 | DD0 |
|-----|-----|-----|--------|------|-----|-----|-----|
| | | | Data \ | Nord | | | |
| | | | Data | Byte | | | |

Error Register

This register contains additional information about the source of an error which has occurred in processing of the preceding command. This register should be checked by the host when ERR bit in the Status register is set. The Error register is a read only register.

| DD7 | DD6 | DD5 | DD4 | DD3 | DD2 | DD1 | DD0 |
|-----|-----|-----|------|-----|------|-----|------|
| BBK | UNC | 0 | IDNF | 0 | ABRT | 0 | AMNF |

| Field | function |
|-------|--|
| BBK | This bit is set when a Bad Block is detected in requested ID field. Host can not read/write on data area that is marked as a Bad Block. |
| UNC | This bit is set when Uncorrectable error is occurred at reading the card. |
| IDNF | The requested sector ID is in error or cannot be found. |
| ABRT | This bit is set if the command has been aborted because of the card status condition. (Not ready, Write fault, etc.) or when an invalid command has been issued. |
| AMNF | This bit is set in case of a general error. |

Feature Register

This register is written by the host to provide command specific information to the drive regarding features of the drive which the host wish to utilize. The Feature register is a write only register.

| DD7 | DD6 | DD5 | DD4 | DD3 | DD2 | DD1 | DD0 |
|-----|-----|-----|---------|--------|-----|-----|-----|
| | | | Feature | e byte | | | |

Sector Count Register

This register is written by the host with the number of sectors or blocks to be processed in the subsequent command. After the command is complete, the host may read this register to obtain the count of sectors left unprocessed by the command.

| DD7 | DD6 | DD5 | DD4 | DD3 | DD2 | DD1 | DD0 |
|-----|-----|-----|--------|-------|-----|-----|-----|
| | | | Sector | Count | | | |

Sector Number Register

This register is written by the host with the starting sector number to be used in the subsequent Cylinder-Head-Sector command. After the command is complete, the host may read the final sector number from this register. When logical block addressing is used, this register is written by the host with bit7 to 0 of the starting logical block number and contains bit7 to 0 of the final logical block number after the command is complete.

| DD7 | DD6 | DD5 | DD4 | DD3 | DD2 | DD1 | DD0 | | |
|---|-----|-----|-----|-----|-----|-----|-----|--|--|
| Sector Number | | | | | | | | | |
| Logical Block Number bits A07-A00(LBA Addressing) | | | | | | | | | |

Cylinder Low Register

This register is written by the host with the low-order byte of the starting cylinder address to be used in the subsequent Cylinder-Head-Sector command. After the command is complete, the host may read the low-order byte of the final cylinder number from this register. When logical block addressing is used, this register is written by the host with bits15 to 8 of the starting logical block number and contains bits15 to 8 of the final logical block number after the command complete.

| DD7 | DD6 | DD5 | DD4 | DD3 | DD2 | DD1 | DD0 | | | |
|-------------------|---|-----|-----|-----|-----|-----|-----|--|--|--|
| Cylinder Low Byte | | | | | | | | | | |
| | Logical Block Number bits A15-A08(LBA Addressing) | | | | | | | | | |

Cylinder High Register

This register is written by the host with the high-order byte of the starting cylinder address to be used in the subsequent Cylinder-Head-Sector command. After the command is complete, the host may read the high-order byte of the final cylinder number from this register. When logical block addressing is used, this register is written by the host with bits 23 to 16 of the starting logical block number and contains bits23 to 16 of the final logical block number after the command is complete.

| DD7 | DD6 | DD5 | DD4 | DD3 | DD2 | DD1 | DD0 | | |
|---|-----|-----|-----|-----|-----|-----|-----|--|--|
| Cylinder High Byte | | | | | | | | | |
| Logical Block Number bits A23-A16(LBA Addressing) | | | | | | | | | |



Drive/Head Register

The Drive/Head register is used to specify the selected drive of a pair of drives sharing a set of registers.

| DD7 | DD6 | DD5 | DD4 | DD3 | DD2 | DD1 | DD0 |
|-----|-----|-----|-----|------|------|------|-------|
| Х | LBA | Х | DRV | HS3 | HS2 | HS1 | HS0 |
| | | | | LBA2 | LBA2 | LBA2 | LBA24 |
| | | | | 7 | 6 | 5 | |

| Field | function |
|-------------------|--|
| Х | Undefined . "0" or "1". |
| LBA | This bit is "0" for CHS addressing and "1" for Logical Block addressing. |
| DRV | This bit is number of the drive which the host has selected. When DRV is cleared, Drive0 is selected. When DRV is set, Drive1 is selected. The card is selected to be Drive0 or to be Drive1 using the "Copy" field of the PC Card Socket Copy Register. |
| HS3-0 LBA27-24 | HS3-0 of the head number in CHS addressing or LBA27-24 of the Logical Block Number in LBA addressing. |

Status and Alternate Status Registers

The Status register and the Alternate Status register return the card status when read by the host. Reading the Status register clears a pending interrupt request while reading the Alternate Status register does not. The Status register and the Alternate Status register are read only registers.

| DD7 | DD6 | DD5 | DD4 | DD3 | DD2 | DD1 | DD0 |
|-----|------|-----|-----|-----|------|-----|---------|
| BSY | DRDY | DWF | DSC | DRQ | CORR | IDX | ER R |

| Field | function |
|-------|--|
| BSY | This bit is set when the card internal operation is executing. When this bit is set to "1", other bits in this register are invalid. |
| DRDY | DRDY indicates whether the card is capable of performing card operations. |
| DWF | This bit, if set, indicates a write fault has occurred. |
| DSC | This bit is set when the drive seek complete. |
| DRQ | This bit is set when the information can be transferred between the host and Data register. |
| CORR | This bit is set when a correctable data error has been occurred and the data has been corrected. |
| IDX | This bit is always set to "0". |
| ERR | This bit is set when the previous command has ended in some type of error. The error information is set in the other Status register bits or Error register. This bit is cleared by the next command. |

Command Register

The Command register contains the command code being sent to the device. Command execution begins immediately after this register is written. The Command register is a write only register.

| DD7 | DD6 | DD5 | DD4 | DD3 | DD2 | DD1 | DD0 |
|-----|-----|-----|------|------|-----|-----|-----|
| | | | Comn | nand | | | |

Device Control Register

This register is used to control the card interrupt request and to issue a soft reset to the card. The Device Control register is a write only register.

| DD7 | DD6 | DD5 | DD4 | DD3 | DD2 | DD1 | DD0 |
|-----|-----|-----|-----|-----|------|------|-----|
| Х | Х | Х | Х | 1 | SRST | nIEN | 0 |

| Field | function |
|-------|---|
| Х | don't care. |
| 1 | This bit is set to "1". |
| SRST | This bit is set to "1" in order to force the card to perform a Command Block Reset operation. This does not change the Card Configuration registers as a Hardware Reset does. The card remains in Reset until this bit is reset to "0". |
| nIEN | This bit is used for enabling IREQ#. When this bit is set to "0", IREQ# is enabled. When this bit is set to "1", IREQ# is disabled. |
| 0 | This bit is set to "0". |

Drive Address Register

This register is provided for compatibility with the AT disk drive interface.

| DD7 | DD6 | DD5 | DD4 | DD3 | DD2 | DD1 | DD0 |
|-----|------|-----|-----|------|-----|------|------|
| Х | nWTG | | nHS | 63-0 | | nDS1 | nDS0 |

| Field | function |
|--------|--|
| Х | This bit is unknown. |
| nWTG | This bit is set to "0" when a Flash write operation is in progress, otherwise it is set to "1". |
| nHS3-0 | These bits is the negative value of Head Select bits in Drive/Head register. |
| nDS1 | This bit is set to "0" when Slave drive is active and selected. |
| nDS0 | This bit is set to "0" when Master drive is active and selected. |



ATA Command Specifications This table summarizes the ATA command set with the paragraphs. Following shows the support commands and command codes which are written in command registers.

| Command | Code | FR | SC | SN | CY | DR | HD |
|--|----------|----|--------------------------------------|---------|----------|----|----|
| Check Power Mode | 98h, E5h | | | | | у | |
| Execute Drive Diagnostic | 90h | | | | | y | |
| Erase Sector(s) | C0h | | у | у | у | ý | у |
| Format Track | 50h | | У | | y | У | У |
| Identify Drive | ECh | | | | | ý | |
| Idle | 97h, E3h | | У | | | У | |
| Idle Immediate | 95h, E1h | | | | | ý | |
| Initialize Drive Parameters | 91h | | у | | | у | у |
| Read Buffer | E4h | | | | | ý | |
| Read DMA | C8h,C9h | | У | у | у | У | У |
| Read Long Sector | 22h, 23h | | | y | y | ý | ý |
| Read Multiple | C4h | | у | y | y | у | у |
| Read Sector(s) | 20h, 21h | | у | y | y | y | y |
| Read Verify Sector(s) | 40h, 41h | | у | y | y | у | у |
| Recalibrate | 1xh | | | | | у | |
| Request Sense | 03h | | | | | у | |
| Seek | 7xh | | | у | у | у | у |
| Set Features | EFh | у | у | | | у | |
| Set Multiple mode | C6h | | у | | | у | |
| Set Sleep Mode | 99h, E6h | | | | | у | |
| Standby | 96h, E2h | | | | | У | |
| Standby Immediate | 94h, E0h | | | | | У | |
| Translate Sector | 87h | | у | у | у | У | У |
| Wear Level | F5h | | | | | У | |
| Write Buffer | E8h | | | | | у | |
| Write DMA | CAh,CBh | | у | у | у | У | У |
| Write Long Sector | 32h, 33h | | | у | у | У | У |
| Write Multiple | C5h | | у | у | у | У | У |
| Write Multiple without Erase | CDh | | у | у | у | У | У |
| Write Sector(s) | 30h, 31h | | у | у | у | У | У |
| Write Sector without Erase | 38h | | у | у | у | У | У |
| Write Verify | 3Ch | | у | у | у | у | у |
| FR : Feature Register, SN : Sector Number Register, DR Drive bit of Drive/Head Register, | | | ector Cou ylinder Lo ead No. (| ow/High | Register | | |



Check Power Mode(98h, E5h)

This command checks the power mode.

Execute Drive Diagnostic(90h)

This command performs the internal diagnostic tests implemented by the card.

Erase Sector(s)(C0h)

This command is used to pre-erase and condition data sectors in advance of a Write without Erase or Write Multiple without Erase command.

Format Track(50h)

This command writes the desired head and cylinder of the selected drive with a FFh pattern.

Identify Drive(ECh)

This command enables the host to receive parameter information from the card. (Refer to the Identify Drive Information table.)

Idle(97h, E3h)

This command causes the card to set BSY, enter the Idle mode, clear BSY and generate an interrupt. If the sector count is non-zero, the automatic power down mode is enabled. If the sector count is zero, the automatic power down mode is disabled.

Idle Immediate(95h, E1h)

This command causes the card to set BSY, enter the idle mode, clear BSY and generate an interrupt.

Initialize Drive Parameters(91h)

This command allows the host to alter the number of sectors per track and the number of heads per cylinder.

Read Buffer(E4h)

This command enables the host to read the current contents of the card's sector buffer.

Read DMA(C8h,C9h)

This command enables the host to read the sector data by the Multiword DMA protocol.

Read Long Sector(22h, 23h)

This command is similar to the Read Sector(s) command except the contents of the Sector Count register are ignored and only one sector is read. The 512 data bytes and 4 ECC bytes are read into the buffer(with no ECC correction) and then transferred to the host.

Read Multiple(C4h)

This command performs similarly to the Read Sector(s) command. Interrupt are not generated on each sector, but on the transfer of a block which contains the number of sectors defined by a Set Multiple command.

Read Sector(s)(20h, 21h)

This command transfers data from the card to the host. Data transfer starts at the sector specified by the Cylinder, Head, and Sector Number registers, and proceeds for the number of sectors specified in the Sector Count register.

Read Verify Sector(s)(40h, 41h)

This command is identical to the Read Sector(s) command, except that DRQ is not asserted, and no data is transferred to the host.

Recalibrate(1xh)

Although this command is supported for backward compatibility, it has no actual function. The card will always return good status at the completion of this command.

Request Sense(03h)

This command requests extended error information for the previous command.

Seek(7xh)

This command is supported for backward compatibility. Although this command has no actual function, it does perform a range check of valid track, and posts an IDNF error if the Head or Cylinder specified are out of bounds.

Set Features(EFh)

This command is used by the host to establish or select certain features.

Set Multiple Mode(C6h)

This command enables the card to perform Read and Write Multiple operations and establishes the block count for these commands. This card supports 1 sector block size.

Set Sleep Mode(99h, E6h)

This command causes the card to set BSY, enter the Sleep mode, clear BSY and generate an interrupt.



Standby(96h, E2h)

This command causes the card to set BSY, enter the Standby mode, clear BSY and generate an interrupt.

Standby Immediate(94h, E0h)

This command causes the card to set BSY, enter the Standby mode, clear BSY and generate an interrupt.

Translate Sector(87h)

This command allows the host to know the number of times an user sector has been erased and programmed. This card doesn't support the Hot Count value.

Wear Leveling(F5h)

Although this command is supported for backward compatibility, it has no actual function. The card will always return good status at the completion of this command.

Write Buffer(E8h)

This command enables the host to overwrite contents of the card's sector buffer with any data pattern desired. This command has the same protocol as the Write Sector(s) command and transfers 512 bytes.

Write DMA(CAh, CBh)

This command enables the host to write sector data by the Multiword DMA protocol.

Write Long Sector(32h, 33h)

This command is similar to the Write Sector(s) except the contents of the Sector Count register are ignored and only one sector is written. The 512 data bytes and 4 ECC bytes are transferred from the host and then written from the buffer to the flash.

Write Multiple(C5h)

This command is similar to the Write Sector(s) command. Interrupts are not presented on each sector, but on the transfer of a block which contains the number of sectors defined by Set Multiple command.

Write Multiple without Erase(CDh)

This command is similar to the Write Multiple command. The sectors should be pre-erased with the Erase Sector command before this command is issued. If the sector is not pre-erased, Write Multiple command operation will occur.

Write Sector(s)(30h, 31h)

This command transfers data from the host to the card. Data transfer starts at the sector specified by the Cylinder, Head, and Sector Number registers, and proceeds for the number of sectors specified in the Sector Count register.

Write Sector without Erase(CDh)

This command is similar to the Write Sector(s) command. The sectors should be pre-erased with the Erase Sector command before this command is issued. If the sector is not pre-erased, Write Sector command operation will occur.

Write Verify(3Ch)

This command is similar to the Write Sector(s) command, except each sector is verified immediately after being written.



Identify Drive Information

| Word Address | Data | | | Description | | | |
|--------------|--------------|------------------------------|---|--|--|--|--|
| 0 | 848Ah | General | configu | ration bit-significant information | | | |
| | | 15 | 1 | Non-rotating disk drive | | | |
| | | 14 | 0 | Format speed tolerance gap not required | | | |
| | | 13 | 0 | Track offset option not available | | | |
| | | 12 | 0 | Data strobe offset option not available | | | |
| | | 11 | 11 0 Rotational speed tolerance is < 0.5% | | | | |
| | | 10 | 1 | Disk transfer rate > 10Mbs | | | |
| | | 9 | 0 | 10Mbs <= Disk transfer rate > 5Mbs | | | |
| | | 8 | 8 0 Disk transfer rate <= 5Mbs | | | | |
| | | 7 | 1 | Removable cartridge drive | | | |
| | | 6 | 0 | Not a fixed drive | | | |
| | | 5 | 0 | Spindle motor control option not implemented | | | |
| | | 4 | 0 | Head switch time > 15us | | | |
| | | 3 | 1 | Not MFM encoded | | | |
| | | 2 | 0 | Not soft sectored | | | |
| | | 1 | 1 | Hard sectored | | | |
| | | 0 | 0 | Reserved | | | |
| 1 | xxxxh | Number | of Cylir | nders | | | |
| 2 | 0000h | Reserve | ed | | | | |
| 3 | 000xh | Number | of Hea | ds | | | |
| 4 | 0000h | Number | of unfo | rmatted bytes per track | | | |
| 5 | 0200h | | | rmatted bytes per sector | | | |
| 6 | 0020h | Number | of sect | ors per track | | | |
| 7-8 | xxxxh, xxxxh | Number | of sect | ors per card (word 7 = MSW, word 8 = LSW) | | | |
| 9 | 0000h | Reserve | Reserved | | | | |
| 10-19 | 2020h | Reserve | ed | | | | |
| 20 | 0001h | Buffer ty | Buffer type: Single ported, single-sector, w/o read cache | | | | |
| 21 | 0001h | Buffer s | ize, in 5 | 12 byte increments | | | |
| 22 | 0004h | ECC ler | ngth use | ed on Read and Write Long command | | | |
| 23-26 | xxxxh | Firmwar | re revisi | on, 8 ASCII characters | | | |
| 27-46 | xxxxh | Model n | umber, | 40 ASCII characters. | | | |
| 47 | 0001h | Maximu | m Block | Count=1 for Read/write Multiple commands | | | |
| 48 | 0000h | Cannot | perform | doubleword I/O | | | |
| 49 | 0300h | Capabili | ties | | | | |
| 50 | 0000h | Reserve | ed | | | | |
| 51 | 0200h | PIO timi | ing cycle | e timing mode 2 | | | |
| 52 | 0000h | Reserve | ed | | | | |
| 53 | 0003h | Words 8 | 54-58 aı | re valid(bit0), words 64-70 are valid(bit1). | | | |
| 54 | xxxxh | Number | of Curr | ent Cylinders | | | |
| 55 | xxxxh | Number | of Curr | rent Heads | | | |
| 56 | xxxxh | Number | ^r of Curr | ent Sectors per Track | | | |
| 57 | xxxxh | LSW of | the Cur | rent Capacity in Sectors | | | |
| 58 | xxxxh | MSW of | f the Cu | rrent Capacity in Sectors | | | |
| 59 | 010xh | | | for Block Count for R/W Multiple commands | | | |
| 60 | xxxxh | | | I number of user addressable LBA mode | | | |
| 61 | xxxxh | MSW of | the tota | al number of user addressable LBA mode | | | |
| 62 | 0000h | Reserve | d | | | | |
| 63 | 0007h | Multiwo | rd DMA | mode2 supported | | | |
| 64 | 0003h | Advanced PIO modes supported | | | | | |
| 65 | 0078h | Minimur | n Multiv | vord DMA transfer cycle time (120ns) | | | |
| 66 | 0078h | Manufa | cturer's | recommended Multiword DMA transfer cycle (120ns) | | | |
| 67 | 00F0h | Minimur | n PIO tr | ransfer cycle time with out flow control (240ns) | | | |
| 68 | 0078h | Minimur | n PIO ti | ransfer cycle time with IORDY (120ns) | | | |
| 69-255 | 0000h | Reserve | ed | | | | |



ABSOLUTE MAXIMUM RATINGS

| Symbol | Parameter | Conditions | Ratings | Unit |
|------------------|-----------------------|------------------------|---------------------------|------|
| V _{DD} | Supply voltage | | -0.3~6.2 | V |
| Vi | Input voltage | With respect to GND | -0.3~V _{DD} +0.3 | V |
| Vo | Output voltage | | -0.3~V _{DD} +0.3 | V |
| Pd | Power dissipation | T _a = 25 °C | 1.2 | W |
| T _{opr} | Operating temperature | | 0~60 | °C |
| T _{stg} | Storage temperature | | -10~80 | °C |

RECOMMENDED OPERATING CONDITIONS

| | Limits | | | | |
|----------------------|--------------------------------|-------------|------|-----------------|------|
| Symbol | Parameter | Min. | Тур. | Max. | Unit |
| V _{DD} (5V) | V _{DD} Supply voltage | 4.5 | 5.0 | 5.5 | V |
| GND | System ground | | 0 | | V |
| VIH | High input voltage | $0.7V_{DD}$ | | V _{DD} | V |
| VIL | Low input voltage | 0 | | 0.8 | V |

DC ELECTRICAL CHARACTERISTICS (Ta=0~60°C, V_{DD}=5V±10%, unless otherwise noted)

| | | | | | Limits | | |
|------------------|--------------------------------------|--|--|--------------------|--------|------|------|
| Symbol | Parameter | Test Condition | | Min. | Тур. | Max. | Unit |
| | | | | 4.5V | | 5.5V | |
| V _{OH} | High output voltage | I _{OH} =4mA(4.5V) | INTRQ, INPACK#, DASP#, PDIAG# | 0.8V _{DD} | | - | v |
| | | I _{OH} =8mA(4.5V) | the other outputs | | | | |
| V _{OL} | Low output voltage | I _{OL} =-4mA(4.5V) | INTRQ, INPACK#, DASP#, PDIAG# | - | | 0.4 | V |
| | | I _{OL} =-8mA(4.5V) | the other outputs | | | | |
| loz | Output current in off state | CS0# = CS1# = V _{IH} | DD15-DD0 | - | | ±10 | μA |
| I _{CCR} | Active supply current (Read) | Output open | | | 70 | 110 | mA |
| Iccw | Active supply current (Write) | | | | 100 | 140 | mA |
| I _{CCS} | Standby current (Auto power down) | $CS0\# = CS1\# = V_{DD}$ DD15-DD0 = GND Other inputs = V_{DD} or GND | | | 2.0 | 4.0 | mA |
| I _{CCD} | Sleep current (Sleep command) | $\begin{array}{l} CS0\# = CS1\# = V_{DD} \\ DD15\text{-}DD0 = GND \\ Other inputs = V_{DD} \ or \end{array}$ | GND | | 500 | 800 | μA |



| | | , | / | Limits | | | |
|-----------------|--------------------|----------------------------------|--|--------|------|------|------|
| Symbol | Parameter | Τe | est Condition | Min. | Тур. | Max. | Unit |
| | | | | 4.5V | | 5.5V | |
| I _{IH} | High input current | V _{IN} =V _{DD} | | -10 | | +10 | μΑ |
| IIL | Low input current | V _{IN} =GND | CS0#, CS1#, DIOR#, DIOW#, DA2-DA0, DD15-DD0 | -10 | | +10 | |
| | | | RESET#, DASP#, PDIAG# | -30 | | -100 | μA |
| | | | CSEL | -10 | | -50 | |

DC ELECTRICAL CHARACTERISTICS(Continued)

CAPACITANCE

| | | | | Limits | | | | |
|---------|--------------------|--------------------------------------|------|--------|------|------|--|--|
| Symbol | Parameter | Test Condition | Min. | Тур. | Max. | Unit | | |
| Cı | Input capacitance | VI=GND, VI=25mVrms, f=1 MHz, Ta=25°C | | | 45 | pF | | |
| Со | Output capacitance | Vo=GND, Vo=25mVrms, f=1 MHz, Ta=25°C | | | 45 | | | |
| Nata 17 | Nate | | | | | | | |

Note : These parameters are not 100% tested.



AC ELECTRICAL CHARACTERISTICS

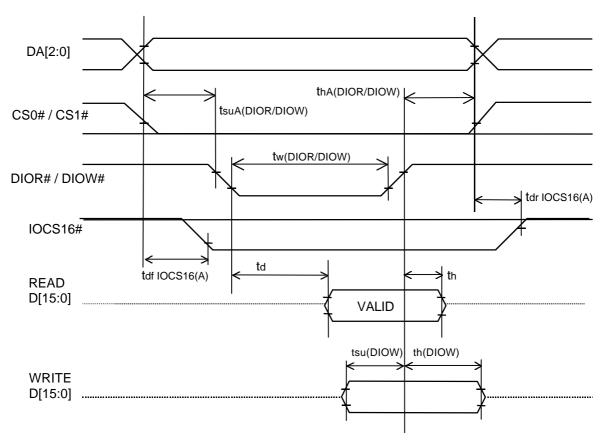
PIO READ /WRITE TIMING

| | | Limit | | |
|-------------------|--|-------|-----|------|
| Symbol | Parameter | Min | Max | Unit |
| tsuA(DIOR / DIOW) | Address Setup before DIOR# / DIOW# * | 25 | | ns |
| thA(DIOR / DIOW) | Address Hold following DIOR# / DIOW# * | 10 | | ns |
| tw(DIOR / DIOW) | DIOR#/DIOW# Width Time | 70 | | ns |
| td(DIOR) | Data Delay after DIOR# | | 50 | ns |
| th(DIOR) | Data Hold following DIOR# | 5 | | ns |
| tsu(DIOW) | Data Setup before DIOW# | 20 | | ns |
| th(DIOW) | Data Hold after DIOW# | 10 | | ns |
| tdfIOCS16(A) | IOCS16# Delay Falling from Address * | | 35 | ns |
| tdrIOCS16(A) | IOCS16# Delay Rising from Address * | | 35 | ns |

The maximum load on IOCS16# are 1 LSTTL with 50 pF total load.

* "Address" includes DA2-DA0 and CS0#, CS1#.

I/O READ / WRITE TIMING DIAGRAM

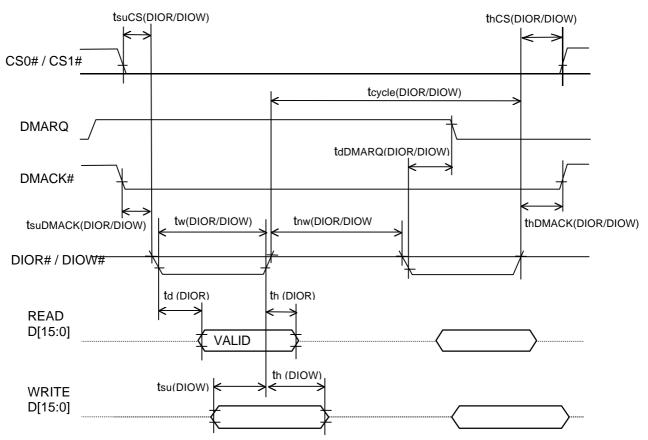




Multiword DMA TIMING

| | Limit | | | |
|--------------------------|--|-----|-----|------|
| Symbol | Parameter | Min | Max | Unit |
| tsuCS(DIOR / DIOW) | CS0#, CS1# Setup before DIOR# / DIOW# | 25 | | ns |
| thCS(DIOR / DIOW) | CS0#, CS1# Hold following DIOR# / DIOW# | 10 | | ns |
| tw(DIOR / DIOW) | DIOR#/DIOW# Width Time | 70 | | ns |
| tnw(DIOR / DIOW) | DIOR#/DIOW# negate pulse Width Time | 35 | | ns |
| tcycle(DIOR / DIOW) | DIOR# / DIOW# Cycle Time | 120 | | ns |
| td(DIOR) | Data Delay after DIOR# | | 50 | ns |
| th(DIOR) | Data Hold following DIOR# | 5 | | ns |
| tsu(DIOW) | Data Setup before DIOW# | 20 | | ns |
| th(DIOW) | Data Hold after DIOW# | 10 | | ns |
| tsuDMACK(DIOR / DIOW) | DMACK# Setup Time before DIOR# / DIOW# | 0 | | ns |
| thDMACK(DIOR / DIOW) | DMACK# Hold Time following DIOR# / DIOW# | 5 | | ns |
| tdDMARQ(DIOR / DIOW) | DMARQ negate delay time from DIOR# / DIOW# | | 35 | ns |

Multiword DMA TIMING DIAGRAM





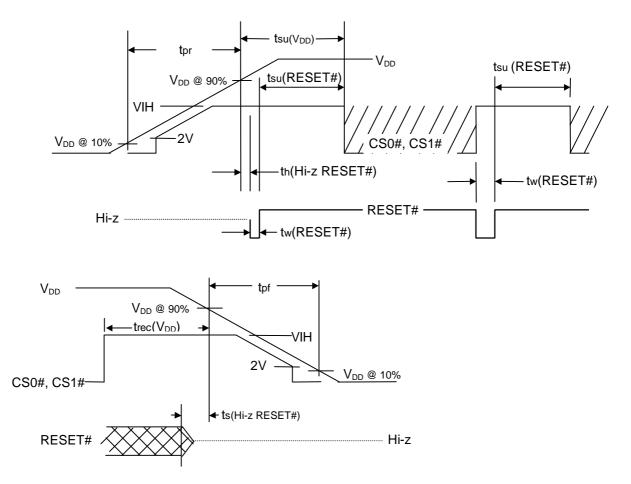
MITSUBISHI STORAGE CARD

MF6XXXX-02BJXX series FLASH DRIVES

RECOMMENDED POWER UP/DOWN CONDITIONS (Ta=0~60°C, unless otherwise noted)

| | | | | Limits | | |
|------------------------|------------------------------|-----------------------------|----------------------|-----------------|----------------------|------|
| Symbol | Parameter | Conditions | Min. | Тур. | Max. | Unit |
| | | $0V \le V_{DD} < 2V$ | 0 | | V _{DD} | V |
| Vi(CS) | CS input voltage | $2V \le V_{DD} < V_{IH}$ | V _{DD} -0.1 | V _{DD} | V _{DD} +0.1 | V |
| | | $V_{IH} \leq V_{DD}$ | VIH | | V _{DD} +0.1 | V |
| tsu(V _{DD}) | CS setup time | | 20 | | | ms |
| tsu(RESET#) | RESET# setup time | | 20 | | | ms |
| trec(V _{DD}) | CS recover time | | 1 | | | μs |
| tpr | V _{DD} rising time | 10%→90% of V _{DD} | 0.1 | | 100 | ms |
| tpf | V _{DD} falling time | 90% of V _{DD} →10% | 3 | | 300 | ms |
| tw(RESET#) | RESET# width | | 10 | | | μs |
| th(Hi-zRESET#) | | | 1 | | | ms |
| ts(Hi-zRESET#) | | | 0 | | | ms |

POWER UP/DOWN TIMING DIAGRAM





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